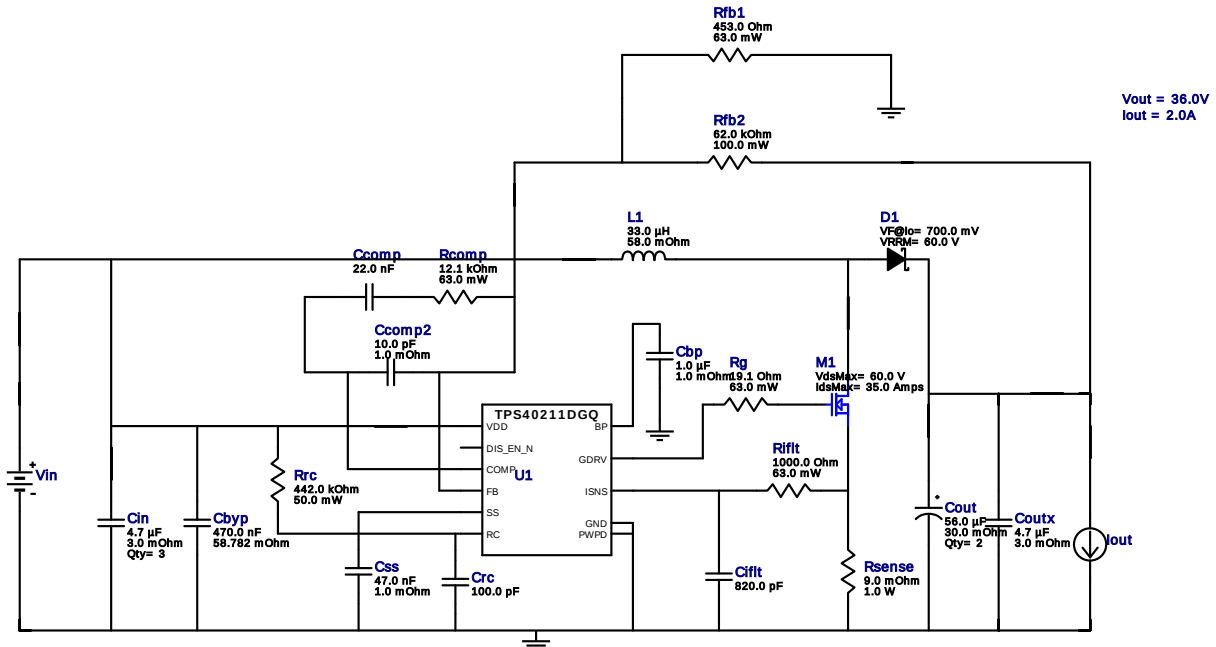


WEBENCH® Design Report

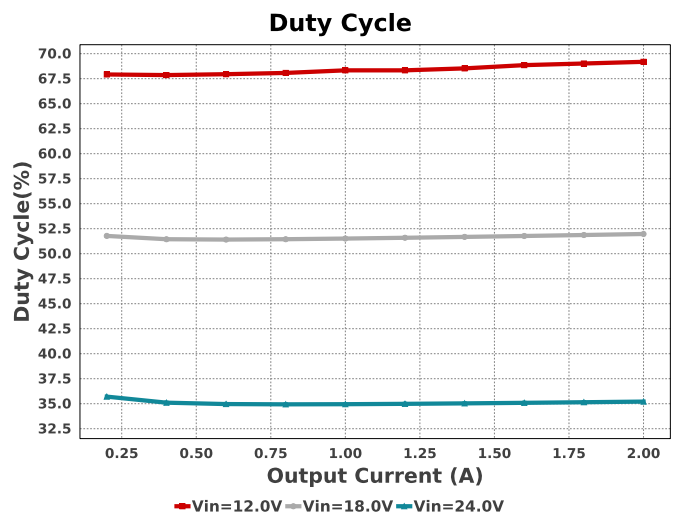
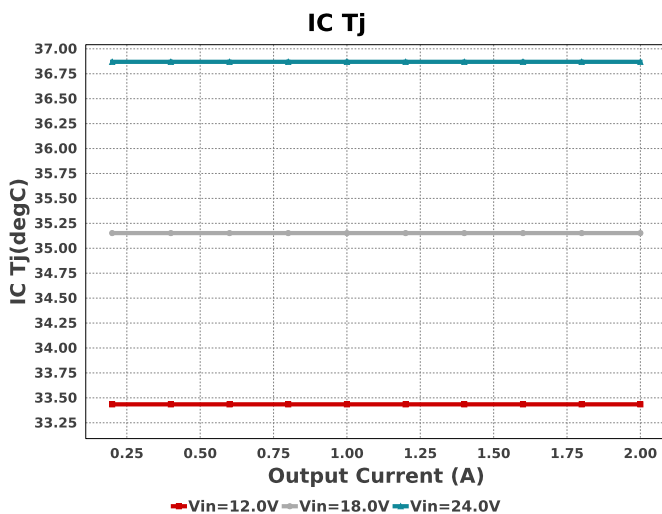
Design : 70 TPS40211DGQR
TPS40211DGQR 12V-24V to 48.00V @ 1.5A



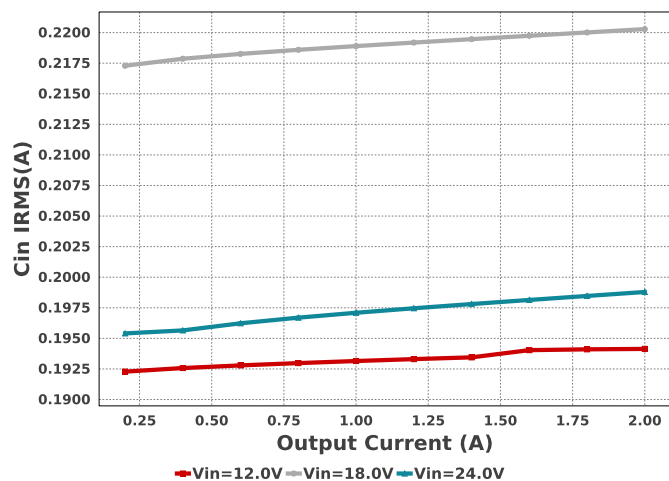
Electrical BOM

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cbp	Taiyo Yuden	EMK107B7105KA-T Series= X7R	Cap= 1.0 µF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm ²
Cbyp	Taiyo Yuden	MSAST219SB5474KTNA01 Series= X5R	Cap= 470.0 nF ESR= 58.782 mOhm VDC= 25.0 V IRMS= 925.89 mA	1	\$0.03	0805 7 mm ²
Ccomp	TDK	CGA4J2C0G1H223J125AA Series= C0G/NP0	Cap= 22.0 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.07	0805 7 mm ²
Ccomp2	MuRata	GRM1555C1H100JA01D Series= C0G/NP0	Cap= 10.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
Cift	Samsung Electro-Mechanics	CL05C821JB5NNNC Series= C0G/NP0	Cap= 820.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
Cin	MuRata	GRM31CR71H475KA12L Series= X7R	Cap= 4.7 µF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A	3	\$0.10	1206 11 mm ²
Cout	Panasonic	EEHZA1J560P Series= ZA	Cap= 56.0 µF ESR= 30.0 mOhm VDC= 63.0 V IRMS= 1.8 A	2	\$0.93	Panasonic_G 151 mm ²
Coutx	MuRata	GRM31CR71H475KA12L Series= X7R	Cap= 4.7 µF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A	1	\$0.10	1206 11 mm ²

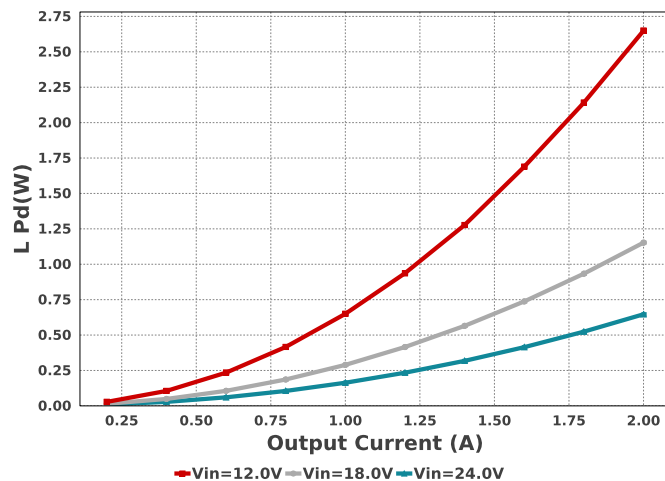
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Crc	Samsung Electro-Mechanics	CL21C101JBANNNC Series= C0G/NP0	Cap= 100.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	 0805 7 mm ²
Css	MuRata	GRM155R71A473KA01D Series= X7R	Cap= 47.0 nF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A	1	\$0.01	 0402 3 mm ²
D1	Diodes Inc.	B560C-13-F	VF@Io= 700.0 mV VRRM= 60.0 V	1	\$0.19	 SMC 83 mm ²
L1	Würth Elektronik	744373965330	L= 33.0 µH 58.0 mOhm	1	\$2.02	WE-LHMI_1365 210 mm ²
M1	Texas Instruments	CSD18543Q3A	VdsMax= 60.0 V IdsMax= 35.0 Amps	1	\$0.21	 DNH0008A 18 mm ²
Rcomp	Yageo	AC0402FR-0712K1L Series= ?	Res= 12.1 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rfb1	Vishay-Dale	CRCW0402453RFKED Series= CRCW..e3	Res= 453.0 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rfb2	Yageo	RC0603FR-0762KL Series= ?	Res= 62.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rg	Vishay-Dale	CRCW040219R1FKED Series= CRCW..e3	Res= 19.1 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rift	Vishay-Dale	CRCW04021K00FKED Series= CRCW..e3	Res= 1000.0 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rrc	Yageo	RC0201FR-07442KL Series= ?	Res= 442.0 kOhm Power= 50.0 mW Tolerance= 1.0%	1	\$0.01	 0201 2 mm ²
Rsense	Susumu Co Ltd	PRL1632-R009-F-T1 Series= PRL1632	Res= 9.0 mOhm Power= 1.0 W Tolerance= 1.0%	1	\$0.20	 0612 11 mm ²
U1	Texas Instruments	TPS40211DGQR	Switcher	1	\$0.58	 DGQ0010D_NV_N 24 mm ²



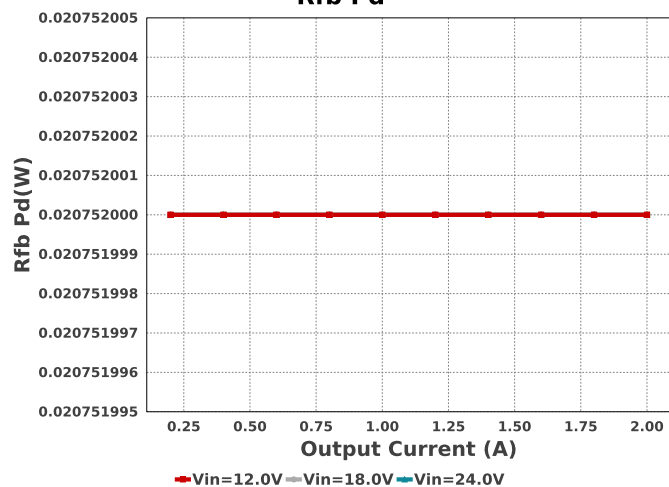
Cin IRMS



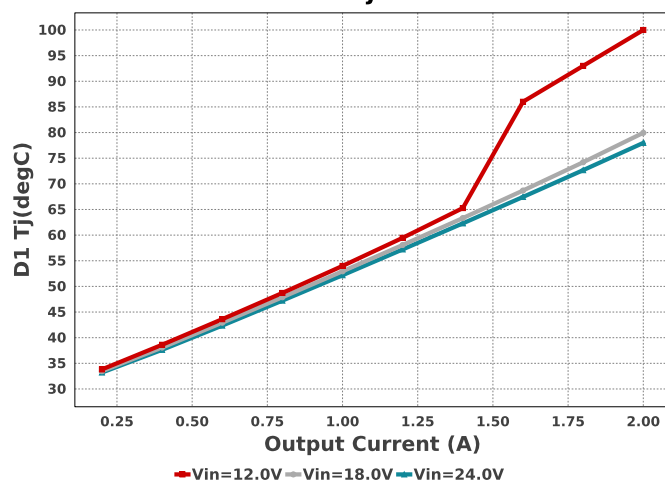
L Pd



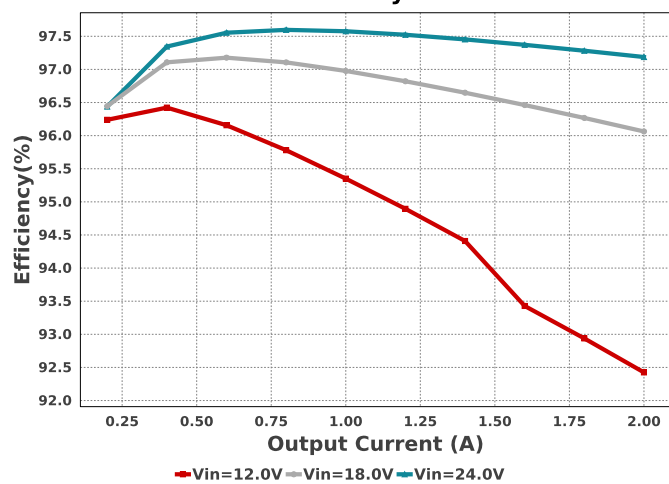
Rfb Pd



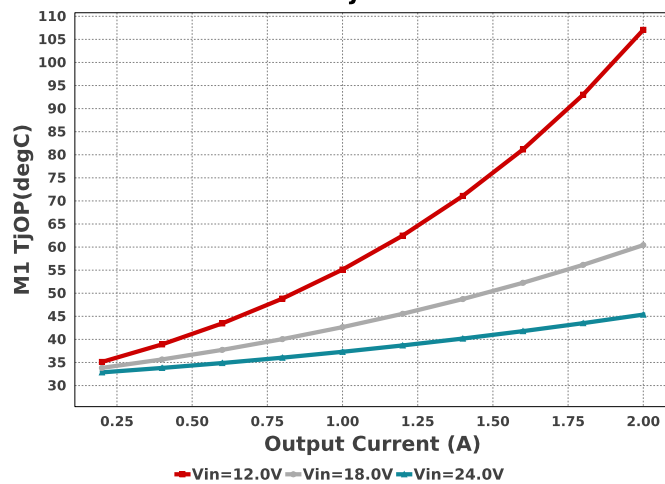
D1 Tj

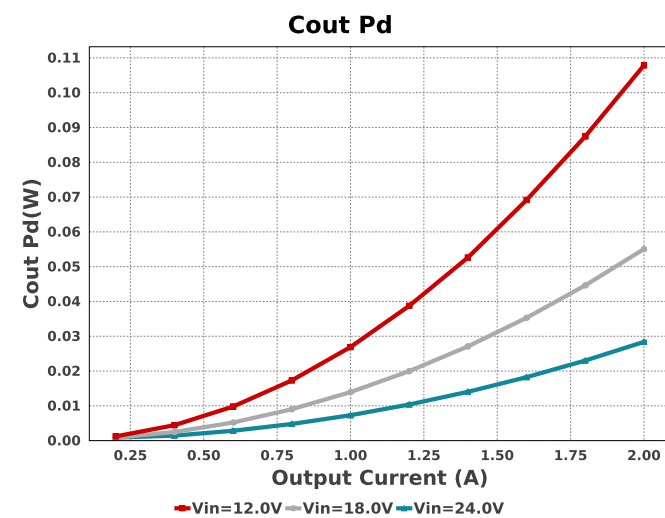
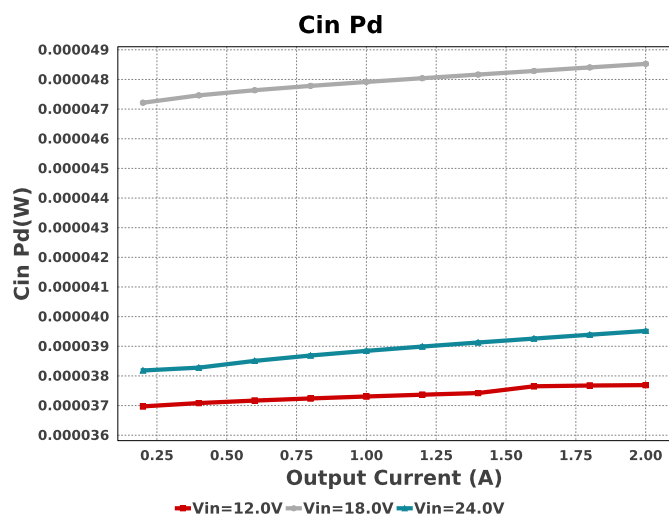
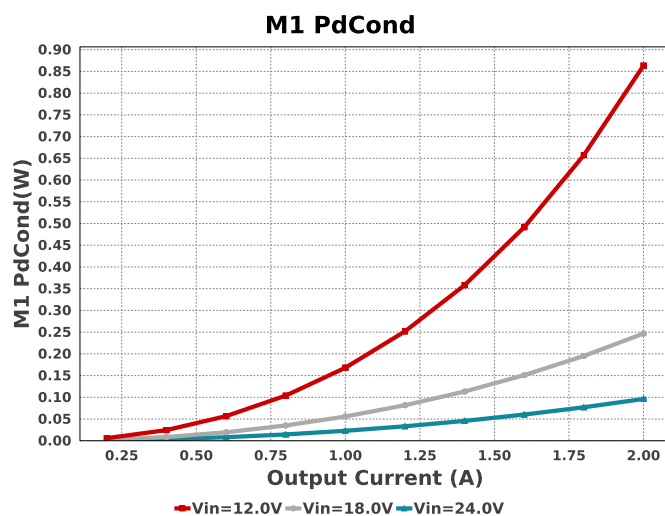
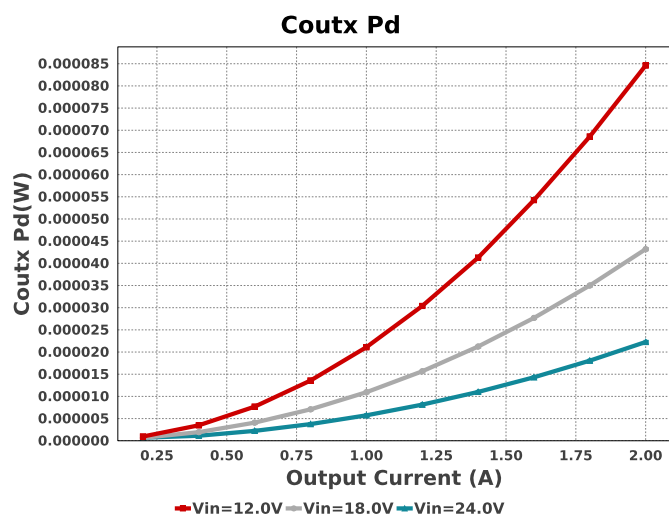
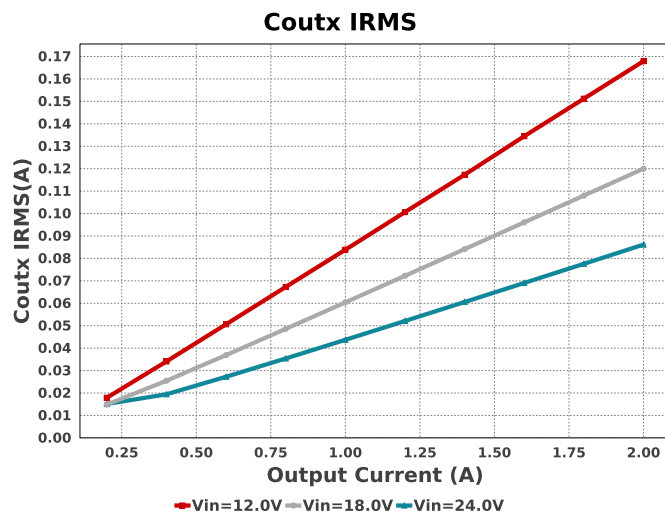
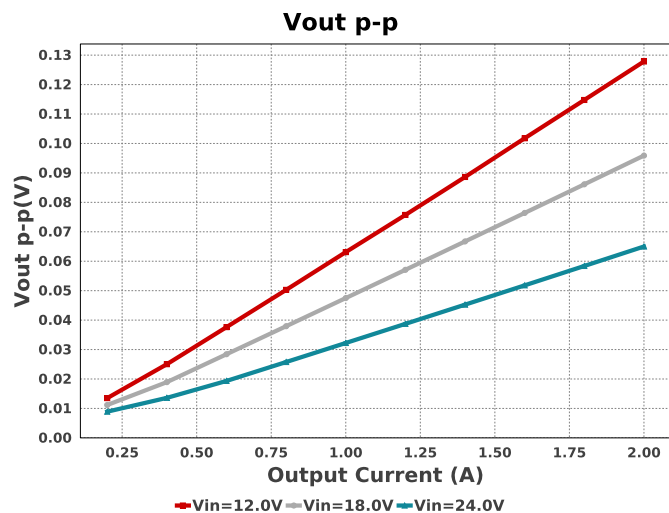


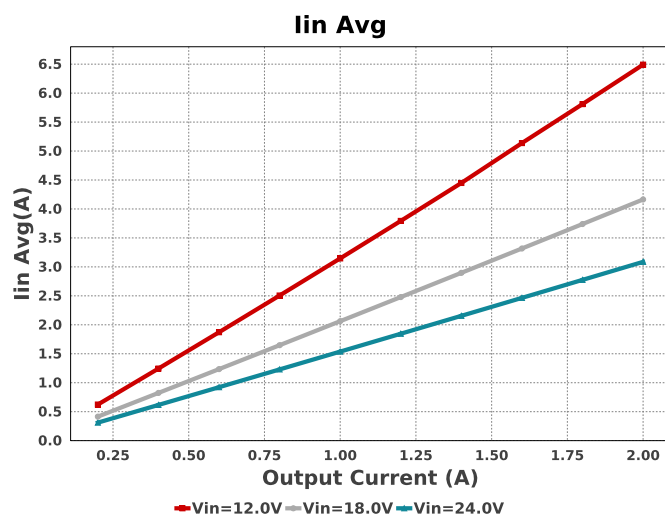
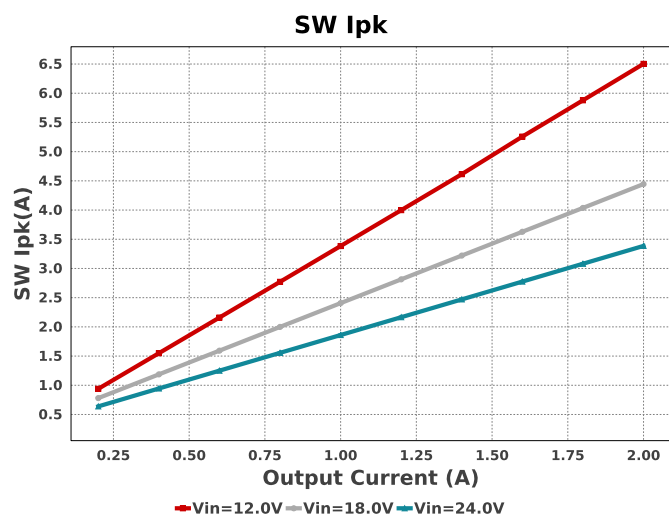
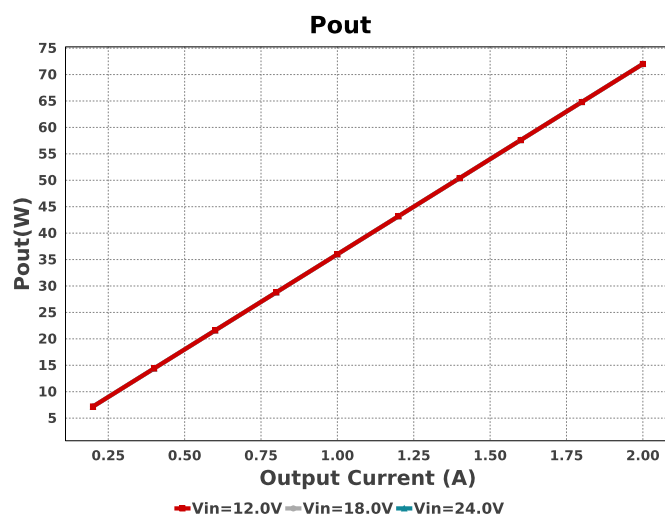
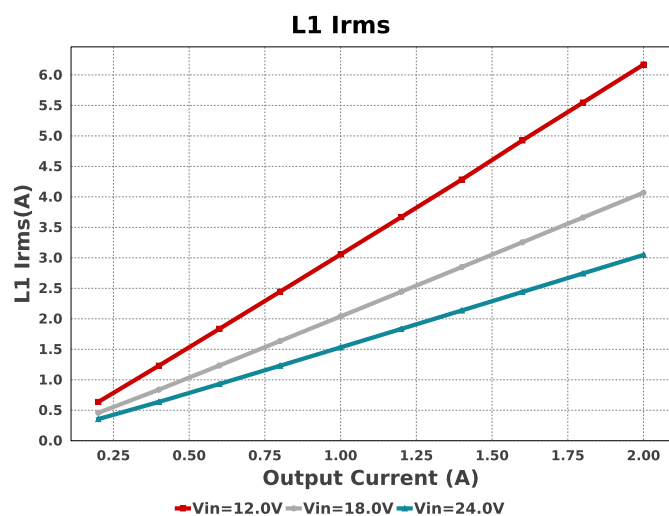
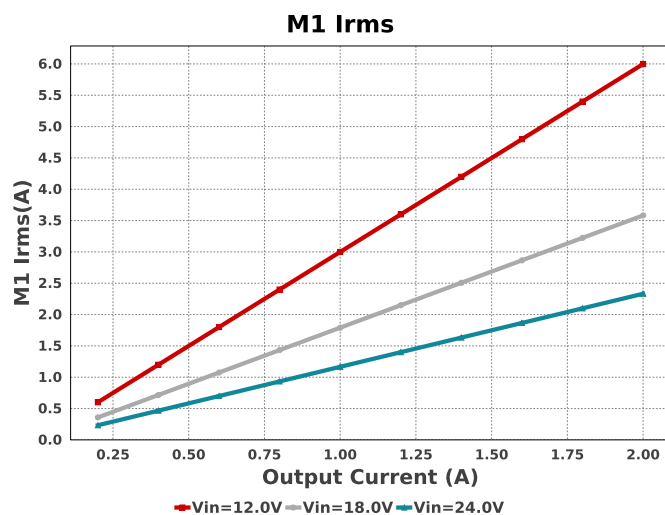
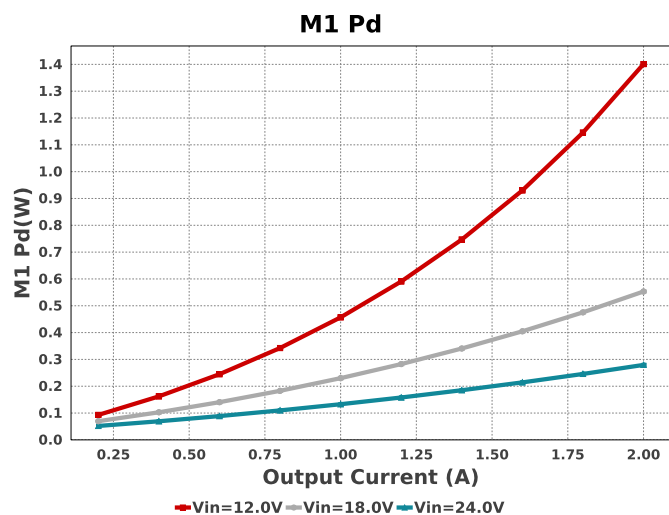
Efficiency



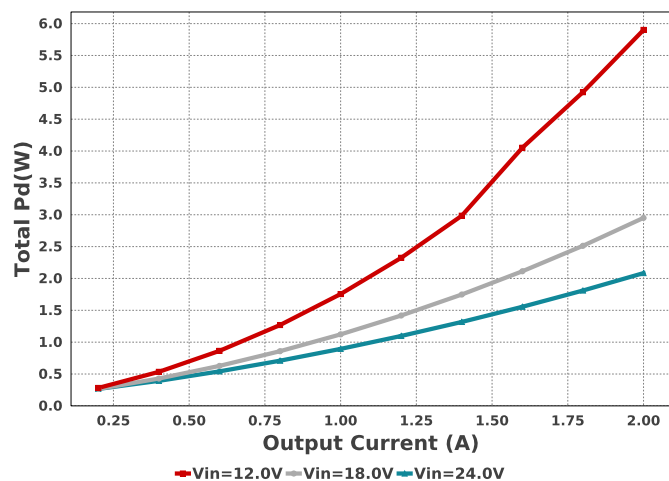
M1 TjOP



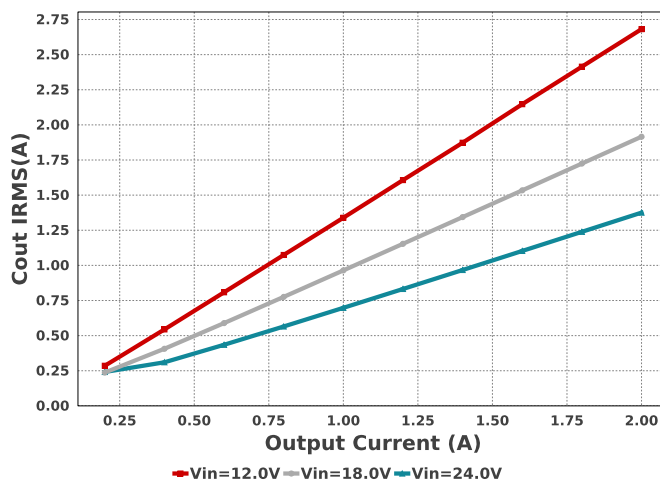




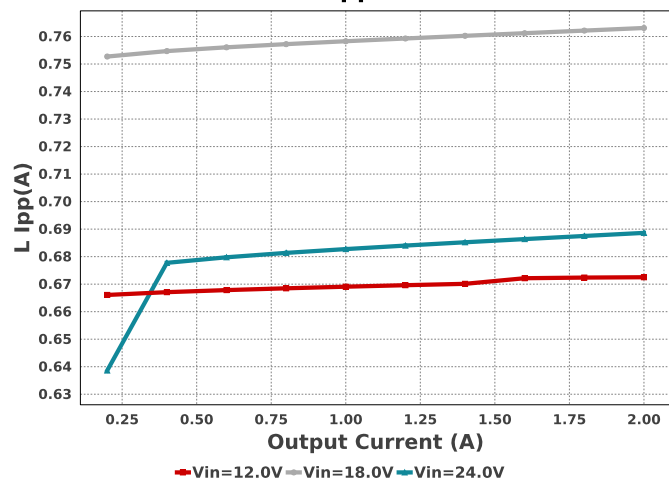
Total Pd



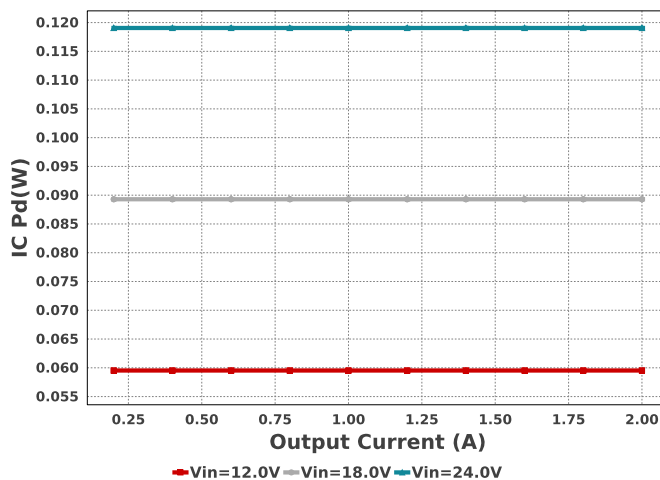
Cout IRMS



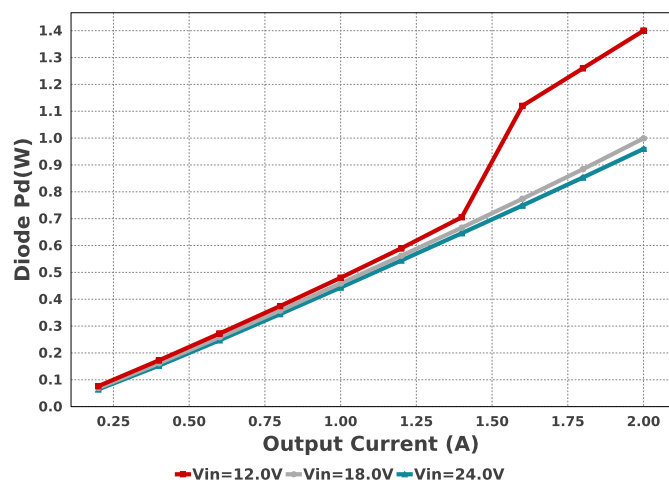
L Ipp



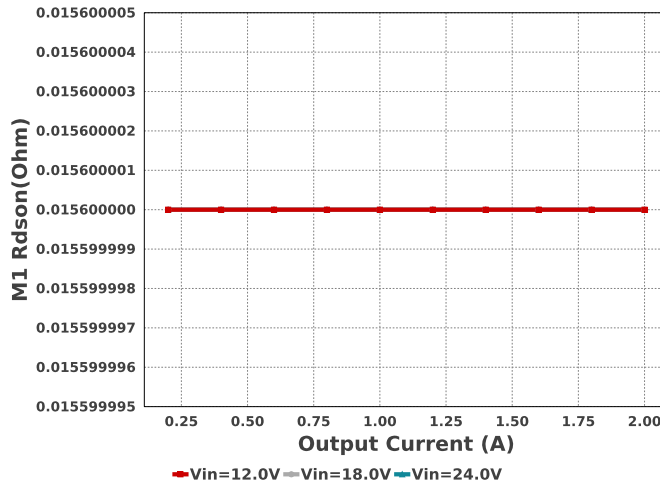
IC Pd



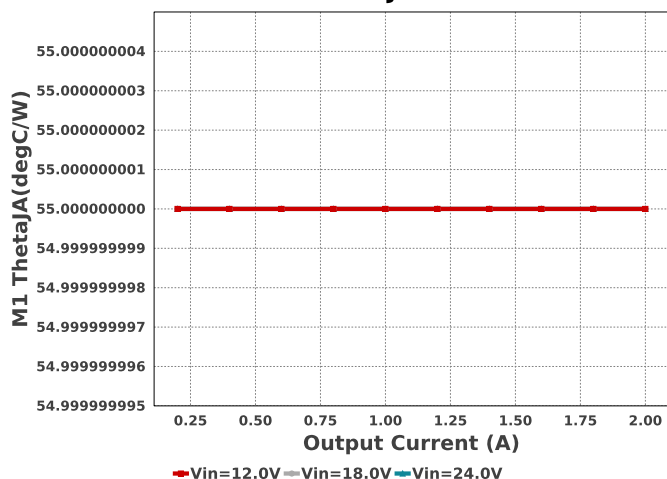
Diode Pd



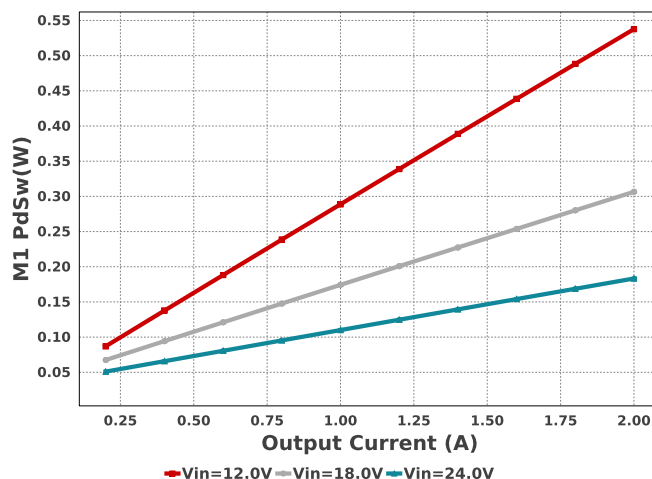
M1 Rdson



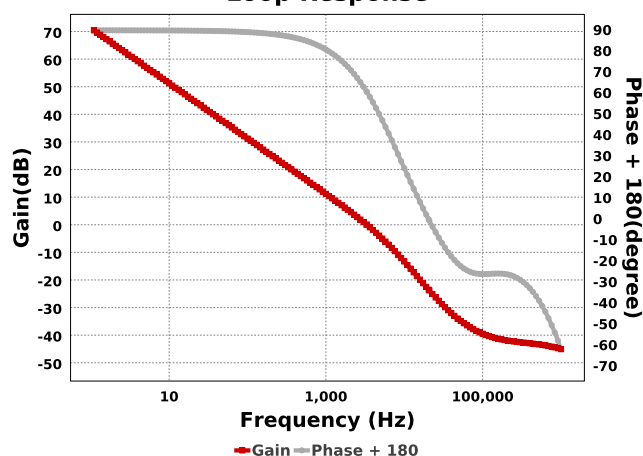
M1 ThetaJA



M1 PdSw



Loop Response



Operating Values

#	Name	Value	Category	Description
1.	BOM Count	24		Total Design BOM count
2.	Total BOM	\$5.672		Total BOM Cost
3.	Cin IRMS	194.138 mA	Capacitor	Input capacitor RMS ripple current
4.	Cin Pd	37.69 μ W	Capacitor	Input capacitor power dissipation
5.	Cout IRMS	2.681 A	Capacitor	Output capacitor RMS ripple current
6.	Cout Pd	107.85 mW	Capacitor	Output capacitor power dissipation
7.	Coutx IRMS	167.935 mA	Capacitor	Output capacitor_x RMS ripple current
8.	Coutx Pd	84.606 μ W	Capacitor	Output capacitor_x power loss
9.	D1 Tj	100.0 degC	Diode	D1 junction temperature
10.	Diode Pd	1.4 W	Diode	Diode power dissipation
11.	IC Pd	59.53 mW	IC	IC power dissipation
12.	IC Tj	33.435 degC	IC	IC junction temperature
13.	IC Tolerance	14.0 mV	IC	IC Feedback Tolerance
14.	ICThetaJA	57.7 degC/W	IC	IC junction-to-ambient thermal resistance
15.	Iin Avg	6.492 A	IC	Average input current
16.	L Ipp	672.514 mA	Inductor	Peak-to-peak inductor ripple current
17.	L Pd	2.649 W	Inductor	Inductor power dissipation
18.	L1 Irms	6.17 A	Inductor	Inductor ripple current
19.	M1 Irms	5.998 A	Mosfet	M1 MOSFET Irms
20.	M1 Pd	1.401 W	Mosfet	M1 MOSFET total power dissipation
21.	M1 PdCond	863.37 mW	Mosfet	M1 MOSFET conduction losses
22.	M1 PdSw	537.71 mW	Mosfet	M1 MOSFET switching losses
23.	M1 Rdson	15.6 mOhm	Mosfet	Drain-Source On-resistance
24.	M1 ThetaJA	55.0 degC/W	Mosfet	MOSFET junction-to-ambient thermal resistance
25.	M1 TjOP	107.059 degC	Mosfet	M1 MOSFET junction temperature
26.	Cin Pd	37.69 μ W	Power	Input capacitor power dissipation
27.	Cout Pd	107.85 mW	Power	Output capacitor power dissipation
28.	Coutx Pd	84.606 μ W	Power	Output capacitor_x power loss
29.	Diode Pd	1.4 W	Power	Diode power dissipation
30.	IC Pd	59.53 mW	Power	IC power dissipation
31.	L Pd	2.649 W	Power	Inductor power dissipation
32.	M1 Pd	1.401 W	Power	M1 MOSFET total power dissipation

#	Name	Value	Category	Description
33.	M1 PdCond	863.37 mW	Power	M1 MOSFET conduction losses
34.	M1 PdSw	537.71 mW	Power	M1 MOSFET switching losses
35.	Rfb Pd	20.752 mW	Power	Rfb Power Dissipation
36.	Total Pd	5.901 W	Power	Total Power Dissipation
37.	Rfb Pd	20.752 mW	Resistor	Rfb Power Dissipation
38.	Cross Freq	1.755 kHz	System	Bode plot crossover frequency
			Information	
39.	Duty Cycle	69.186 %	System	Duty cycle
			Information	
40.	Efficiency	92.425 %	System	Steady state efficiency
			Information	
41.	FootPrint	745.0 mm ²	System	Total Foot Print Area of BOM components
			Information	
42.	Frequency	366.19 kHz	System	Switching frequency
			Information	
43.	Gain Marg	-14.433 dB	System	Bode Plot Gain Margin
			Information	
44.	Iout	2.0 A	System	Iout operating point
			Information	
45.	Low Freq Gain	72.966 dB	System	Gain at 1Hz
			Information	
46.	Mode	CCM	System	Conduction Mode
			Information	
47.	Phase Marg	60.225 deg	System	Bode Plot Phase Margin
			Information	
48.	Pout	72.0 W	System	Total output power
			Information	
49.	SW Ipk	6.503 A	System	Peak switch current
			Information	
50.	Vin	12.0 V	System	Vin operating point
			Information	
51.	Vout	36.0 V	System	Operational Output Voltage
			Information	
52.	Vout Actual	35.845 V	System	Vout Actual calculated based on selected voltage divider resistors
			Information	
53.	Vout Tolerance	7.498 %	System	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
			Information	
54.	Vout p-p	127.845 mV	System	Peak-to-peak output ripple voltage
			Information	

Design Inputs

Name	Value	Description
Iout	2.0	Maximum Output Current
VinMax	24.0	Maximum input voltage
VinMin	12.0	Minimum input voltage
Vout	36.0	Output Voltage
base_pn	TPS40211	Base Product Number
source	DC	Input Source Type
Ta	30.0	Ambient temperature

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

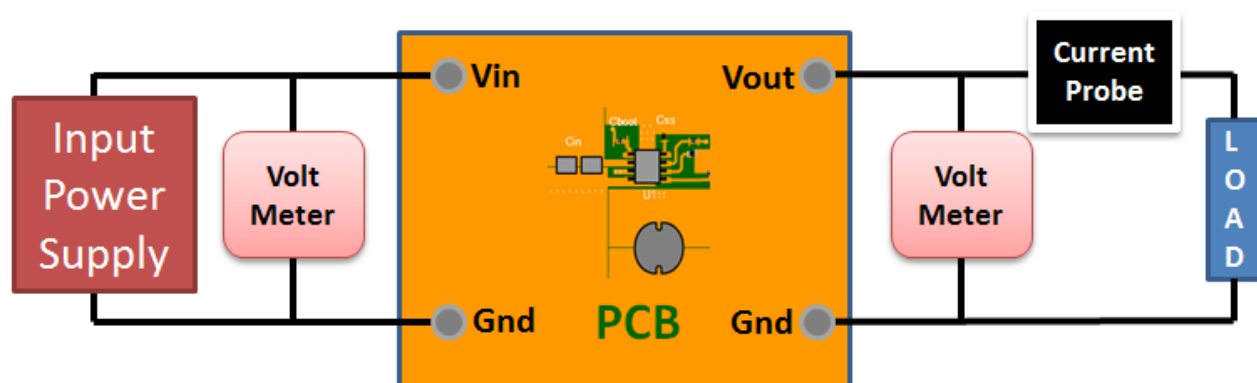
If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 12.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum load of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



Design Assistance

1. Master key : 2AD6C0AD9A62E52B[v1]
2. **TPS40211** Product Folder : <http://www.ti.com/product/TPS40211> : contains the data sheet and other resources.

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